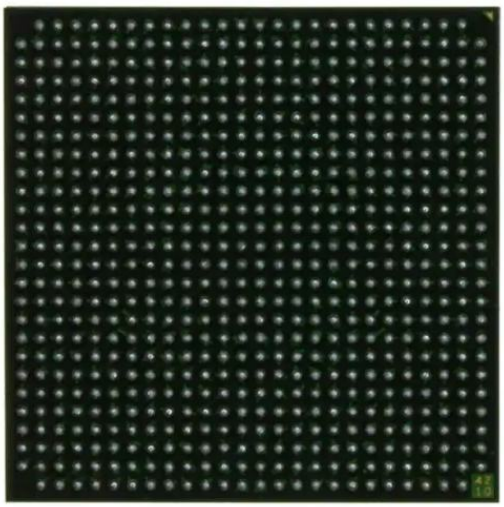

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1232
Number of Logic Elements/Cells	11088
Total RAM Bits	811008
Number of I/O	396
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FCBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp7-7ffg672c

Functional Description: Processor Block

This section briefly describes the interfaces and components of the Processor Block. The subsequent section, Functional Description: Embedded PowerPC 405 Core beginning on page 20, offers a summary of major PPC405 core features. For an in-depth discussion on both the Processor Block and PPC405, see tthe **PowerPC Processor Reference Guide** and the **PowerPC 405 Processor Block Reference Guide** available on the Xilinx website at **http://www.xilinx.com**.

Processor Block Overview

Figure 14 shows the internal architecture of the Processor Block.

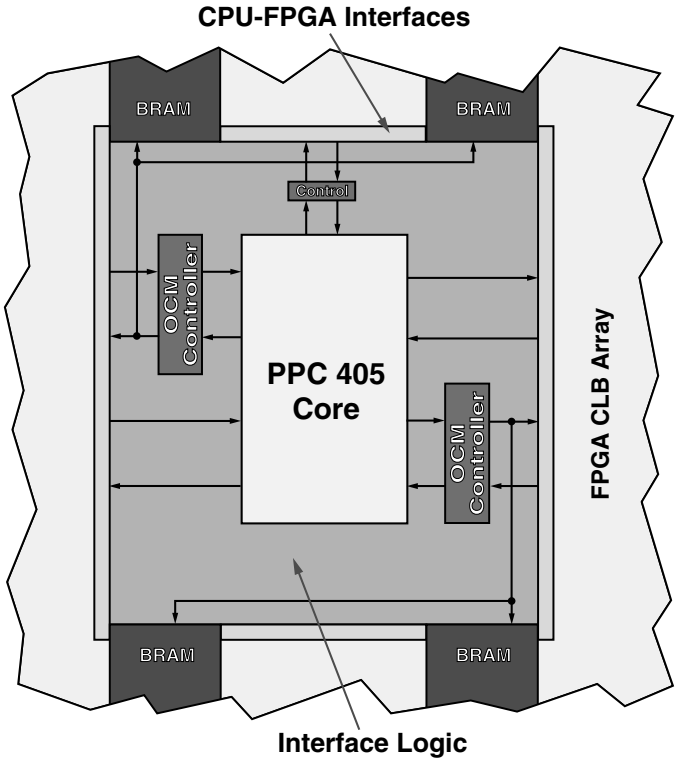


Figure 14: **Processor Block Architecture**

Within the Virtex-II Pro Processor Block, there are four components:

- Embedded IBM PowerPC 405-D5 RISC CPU core
- On-Chip Memory (OCM) controllers and interfaces
- Clock/control interface logic
- CPU-FPGA Interfaces

Embedded PowerPC 405 RISC Core

The PowerPC 405D5 core is a 0.13 µm implementation of the IBM PowerPC 405D4 core. The advanced process technology enables the embedded PowerPC 405 (PPC405) core to operate at 300+ MHz while maintaining low power consumption. Specially designed interface logic integrates the core with the surrounding CLBs, block RAMs, and general routing resources. Up to four Processor Blocks can be available in a single Virtex-II Pro device.

The embedded PPC405 core implements the PowerPC User Instruction Set Architecture (UISA), user-level registers, programming model, data types, and addressing modes for 32-bit fixed-point operations. 64-bit operations, auxiliary processor operations, and floating-point operations are trapped and can be emulated in software.

Most of the PPC405 core features are compatible with the specifications for the PowerPC Virtual Environment Architecture (VEA) and Operating Environment Architecture (OEA). They also provide a number of optimizations and extensions to the lower layers of the PowerPC Architecture. The full architecture of the PPC405 is defined by the PowerPC Embedded Environment and PowerPC UISA documentation, available from IBM.

On-Chip Memory (OCM) Controllers

Introduction

The OCM controllers serve as dedicated interfaces between the block RAMs in the FPGA fabric (see 18 Kb Block SelectRAM+ Resources, page 44) and OCM signals available on the embedded PPC405 core. The OCM signals on the PPC405 core are designed to provide very quick access to a fixed amount of instruction and data memory space. The OCM controller provides an interface to both the 64-bit Instruction-Side Block RAM (ISBRAM) and the 32-bit Data-Side Block RAM (DSBRAM). The designer can choose to implement:

- ISBRAM only
- DSBRAM only
- Both ISBRAM and DSBRAM
- No ISBRAM and no DSBRAM

One of OCM's primary advantages is that it guarantees a fixed latency of execution for a higher level of determinism. Additionally, it reduces cache pollution and thrashing, since the cache remains available for caching code from other memory resources.

Typical applications for DSOCM include scratch-pad memory, as well as use of the dual-port feature of block RAM to enable bidirectional data transfer between processor and FPGA. Typical applications for ISOCM include storage of interrupt service routines.

Functional Features

Common Features

- Separate Instruction and Data memory interface between processor core and BRAMs in FPGA
- Dedicated interface to Device Control Register (DCR) bus for ISOCM and DSOCM

Table 27: **RocketIO Transmitter Switching Characteristics**

Description	Symbol	Conditions	Min	Typ	Max	Units
Serial data rate, full-speed clock	F_{GTX}	Flipchip packages	1.0		3.125(1)	Gb/s
		Wirebond packages	1.0		2.5(1)	Gb/s
Serial data rate, half-speed clock(3) (2X oversampling)		Flipchip packages	0.600		1.0	Gb/s
		Wirebond packages	0.600		1.0	Gb/s
Serial data output deterministic jitter	T_{DJ}	2.126 Gb/s – 3.125 Gb/s			0.17	UI(2)
		1.0626 Gb/s – 2.125 Gb/s			0.08	UI
		1.0 Gb/s – 1.0625 Gb/s			0.05	UI
		600 Mb/s – 999 Mb/s			0.08(4)	UI
Serial data output random jitter	T_{RJ}	2.126 Gb/s – 3.125 Gb/s			0.18	UI
		1.0626 Gb/s – 2.125 Gb/s			0.19	UI
		1.0 Gb/s – 1.0625 Gb/s			0.18	UI
		600 Mb/s – 999 Mb/s			0.18(4)	UI
TX rise time	T_{RTX}	20% – 80%		120		ps
TX fall time	T_{FTX}			120		ps
Transmit latency(5)	T_{TXLAT}	Including CRC		14	17	TXUSR CLK cycles
		Excluding CRC		8	11	
TXUSRCLK duty cycle	T_{TXDC}		45	50	55	%
TXUSRCLK2 duty cycle	T_{TX2DC}		45	50	55	%

Notes:
1. Serial data rate in the -5 speed grade is limited to 2.0 Gb/s in both wirebond and flipchip packages.
2. UI = Unit Interval
3. For serial rates under 1 Gb/s, the 3X (or greater) oversampling techniques described in **XAPP572** are required to meet the transmit jitter and receive jitter tolerance specifications defined in this data sheet.
4. The oversampling techniques described in **XAPP572** are required to meet these specifications for serial rates less than 1 Gb/s.
5. Transmit latency delay TXDATA to TXP/TXN. Refer to ***RocketIO Transceiver User Guide*** for more information on calculating latency.

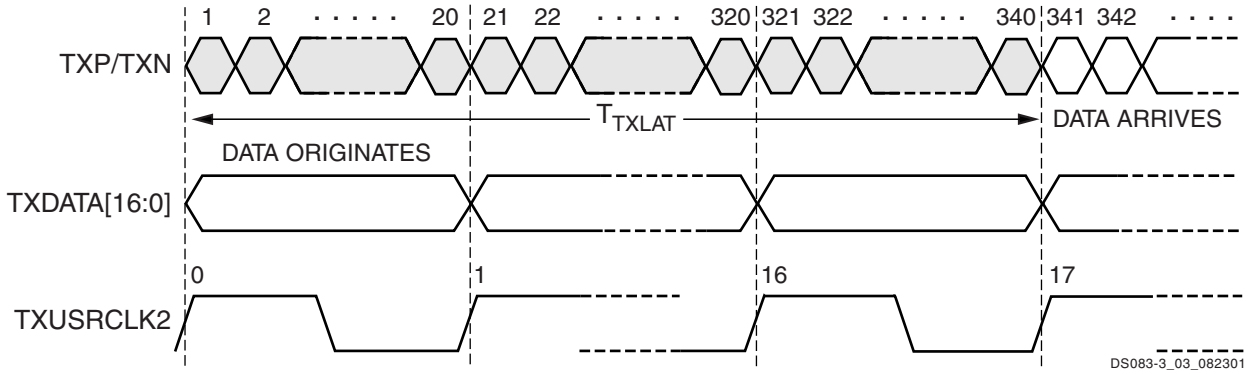


Figure 5: **RocketIO Transmit Latency (Maximum, Including CRC)**

IOB Input Switching Characteristics

Input delays associated with the pad are specified for LVCMOS 2.5V levels. For other standards, adjust the delays with the values shown in IOB Input Switching Characteristics Standard Adjustments.

Table 35: **IOB Input Switching Characteristics**

			Speed Grade			
Description	**Symbol**	**Device**	**-7**	**-6**	**-5**	**Units**
Propagation Delays						
Pad to I output, no delay	T_{IOPI}	All	0.84	0.87	0.91	ns, max
Pad to I output, with delay	T_{IOPID}	XC2VP2	1.84	1.94	2.06	ns, max
		XC2VP4	1.84	1.94	2.06	ns, max
		XC2VP7	1.84	1.94	2.06	ns, max
		XC2VP20	2.14	2.23	2.37	ns, max
		XC2VPX20	2.14	2.23	2.37	ns, max
		XC2VP30	2.14	2.26	2.46	ns, max
		XC2VP40	2.54	2.67	2.81	ns, max
		XC2VP50	2.54	2.68	2.87	ns, max
		XC2VP70	2.54	2.72	2.91	ns, max
		XC2VPX70	2.54	2.72	2.91	ns, max
		XC2VP100	N/A	4.71	4.80	ns, max
Propagation Delays						
Pad to output IQ via transparent latch, no delay	T_{IOPLI}	All	0.86	0.89	0.93	ns, max
Pad to output IQ via transparent latch, with delay	T_{IOPLID}	XC2VP2	2.30	2.62	2.97	ns, max
		XC2VP4	2.57	2.89	3.23	ns, max
		XC2VP7	2.50	2.84	3.17	ns, max
		XC2VP20	2.65	3.04	3.42	ns, max
		XC2VPX20	2.65	3.04	3.42	ns, max
		XC2VP30	2.69	3.12	3.51	ns, max
		XC2VP40	3.30	3.63	4.03	ns, max
		XC2VP50	3.86	4.10	4.45	ns, max
		XC2VP70	4.00	4.25	4.57	ns, max
		XC2VPX70	4.00	4.25	4.57	ns, max
		XC2VP100	N/A	6.50	7.06	ns, max
Clock CLK to output IQ	T_{IOCKIQ}	All	0.60	0.60	0.67	ns, max

Table 46: **Pipelined Multiplier Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Setup and Hold Times Before/After Clock					
Data Inputs	$T_{MULIDCK}/T_{MULCKID}$	1.86/ 0.00	2.06/ 0.00	2.31/ 0.00	ns, max
Clock Enable	$T_{MULIDCK\_CE}/T_{MULCKID\_CE}$	0.23/ 0.00	0.25/ 0.00	0.28/ 0.00	ns, max
Reset	$T_{MULIDCK\_RST}/T_{MULCKID\_RST}$	0.21/–0.09	0.24/–0.09	0.26/–0.10	ns, max
Clock to Output Pin					
Clock to Pin35	T_{MULTCK_P35}	2.45	2.92	3.27	ns, max
Clock to Pin34	T_{MULTCK_P34}	2.36	2.82	3.16	ns, max
Clock to Pin33	T_{MULTCK_P33}	2.28	2.72	3.05	ns, max
Clock to Pin32	T_{MULTCK_P32}	2.20	2.62	2.93	ns, max
Clock to Pin31	T_{MULTCK_P31}	2.12	2.52	2.82	ns, max
Clock to Pin30	T_{MULTCK_P30}	2.03	2.42	2.71	ns, max
Clock to Pin29	T_{MULTCK_P29}	1.95	2.32	2.60	ns, max
Clock to Pin28	T_{MULTCK_P28}	1.87	2.22	2.48	ns, max
Clock to Pin27	T_{MULTCK_P27}	1.79	2.12	2.37	ns, max
Clock to Pin26	T_{MULTCK_P26}	1.70	2.02	2.26	ns, max
Clock to Pin25	T_{MULTCK_P25}	1.62	1.92	2.15	ns, max
Clock to Pin24	T_{MULTCK_P24}	1.54	1.82	2.03	ns, max
Clock to Pin23	T_{MULTCK_P23}	1.46	1.71	1.92	ns, max
Clock to Pin22	T_{MULTCK_P22}	1.37	1.61	1.81	ns, max
Clock to Pin21	T_{MULTCK_P21}	1.29	1.51	1.69	ns, max
Clock to Pin20	T_{MULTCK_P20}	1.21	1.41	1.58	ns, max
Clock to Pin19	T_{MULTCK_P19}	1.13	1.31	1.47	ns, max
Clock to Pin18	T_{MULTCK_P18}	1.04	1.21	1.36	ns, max
Clock to Pin17	T_{MULTCK_P17}	0.96	1.11	1.24	ns, max
Clock to Pin16	T_{MULTCK_P16}	0.88	1.01	1.13	ns, max
Clock to Pin15	T_{MULTCK_P15}	0.80	0.91	1.02	ns, max
Clock to Pin14	T_{MULTCK_P14}	0.71	0.81	0.91	ns, max
Clock to Pin13	T_{MULTCK_P13}	0.63	0.71	0.79	ns, max
Clock to Pin12	T_{MULTCK_P12}	0.63	0.71	0.79	ns, max
Clock to Pin11	T_{MULTCK_P11}	0.63	0.71	0.79	ns, max
Clock to Pin10	T_{MULTCK_P10}	0.63	0.71	0.79	ns, max
Clock to Pin9	T_{MULTCK_P9}	0.63	0.71	0.79	ns, max
Clock to Pin8	T_{MULTCK_P8}	0.63	0.71	0.79	ns, max
Clock to Pin7	T_{MULTCK_P7}	0.63	0.71	0.79	ns, max
Clock to Pin6	T_{MULTCK_P6}	0.63	0.71	0.79	ns, max
Clock to Pin5	T_{MULTCK_P5}	0.63	0.71	0.79	ns, max
Clock to Pin4	T_{MULTCK_P4}	0.63	0.71	0.79	ns, max
Clock to Pin3	T_{MULTCK_P3}	0.63	0.71	0.79	ns, max
Clock to Pin2	T_{MULTCK_P2}	0.63	0.71	0.79	ns, max
Clock to Pin1	T_{MULTCK_P1}	0.63	0.71	0.79	ns, max
Clock to Pin0	T_{MULTCK_P0}	0.63	0.71	0.79	ns, max

Date	Version	Revision
09/15/05	4.4	• Table 2: Added Footnote (7) to AVCCAUXRX for RocketIO X (1.8V for all non-8B/10B-encoded data). • Table 3: - Power dissipation for 10.3125 Gb/s deleted. - Max $I_{CCAUXTX}$ and $I_{CCAUXRX}$ specifications added for Virtex-II Pro. • Table 11: Added specification for minimum p-p differential input voltage. • Table 22: - F_{GCLK}: Changed high end of range to 425 MHz. - T_{GJTT}: Changed measurement units to picoseconds and added maximum specifications for two bit rate ranges. - T_{LOCK}: Changed measurement units to microseconds and adderd typical specification. - T_{PHASE}: Changed measurement units to microseconds and adderd typical and maximum specifications. • Table 24: - All parameters: Deleted specifications for 10.3125 Gb/s. - T_{RJTOL}: Added typical specifications. - T_{JTOL}, T_{SJTOL}, and T_{DDJTOL}: Added typical and maximum specifications. • Table 26: Restructured table. Total Jitter parameter added. All jitter parameters respecified. • Table 28: Restructured table and added new specifications.
10/10/05	4.5	• Changed XC2VPX70 variable baud rate specification to fixed-rate operation at 4.25 Gb/s. • Table 15: Removed -7 designations for XC2VPX20 and XC2VPX70 devices.
03/05/07	4.6	*No changes in Module 3 for this revision.*
11/05/07	4.7	Updated copyright notice and legal disclaimer.
06/21/11	5.0	Added *Product Not Recommended for New Designs* banner. Changed I_{TRX} typical value in Table 3.

Notice of Disclaimer

Virtex-II Pro Data Sheet

The Virtex-II Pro Data Sheet contains the following modules:

- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Functional Description (Module 2)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information (Module 4)

Table 5: **FG256/FGG256 — XC2VP2 and XC2VP4**

Bank	Pin Description	Pin Number
7	IO_L85N_7	G2
7	IO_L06P_7	G3
7	IO_L06N_7	G4
7	IO_L04P_7	F1
7	IO_L04N_7/VREF_7	F2
7	IO_L03P_7	F3
7	IO_L03N_7	F4
7	IO_L02P_7	F5
7	IO_L02N_7	E4
7	IO_L01P_7/VRN_7	E2
7	IO_L01N_7/VRP_7	E3
0	VCCO_0	F8
0	VCCO_0	F7
0	VCCO_0	E8
1	VCCO_1	F9
1	VCCO_1	F10
1	VCCO_1	E9
2	VCCO_2	H12
2	VCCO_2	H11
2	VCCO_2	G11
3	VCCO_3	K11
3	VCCO_3	J12
3	VCCO_3	J11
4	VCCO_4	M9
4	VCCO_4	L9
4	VCCO_4	L10
5	VCCO_5	M8
5	VCCO_5	L8
5	VCCO_5	L7
6	VCCO_6	K6
6	VCCO_6	J6
6	VCCO_6	J5
7	VCCO_7	H6
7	VCCO_7	H5

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
7	IO_L04N_7/VREF_7	E2			
7	IO_L03P_7	F5			
7	IO_L03N_7	E4			
7	IO_L02P_7	D1			
7	IO_L02N_7	D2			
7	IO_L01P_7/VRN_7	C1			
7	IO_L01N_7/VRP_7	C2			
0	VCCO_0	C5			
0	VCCO_0	C8			
0	VCCO_0	D11			
0	VCCO_0	J10			
0	VCCO_0	J11			
0	VCCO_0	K12			
0	VCCO_0	K13			
1	VCCO_1	C19			
1	VCCO_1	C22			
1	VCCO_1	D16			
1	VCCO_1	J16			
1	VCCO_1	J17			
1	VCCO_1	K14			
1	VCCO_1	K15			
2	VCCO_2	E24			
2	VCCO_2	H24			
2	VCCO_2	K18			
2	VCCO_2	L18			
2	VCCO_2	L23			
2	VCCO_2	M17			
2	VCCO_2	N17			
3	VCCO_3	P17			
3	VCCO_3	R17			
3	VCCO_3	T18			
3	VCCO_3	T23			
3	VCCO_3	U18			
3	VCCO_3	W24			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
5	IO_L74P_5/GCLK4P	AB14			
5	IO_L73N_5	AA14			
5	IO_L73P_5	Y14			
5	IO_L69N_5/VREF_5	W14			
5	IO_L69P_5	W15			
5	IO_L68N_5	AD15			
5	IO_L68P_5	AC15			
5	IO_L67N_5	AB15			
5	IO_L67P_5	AA15			
5	IO_L45N_5/VREF_5	AC16	NC	NC	
5	IO_L45P_5	AB16	NC	NC	
5	IO_L44N_5	Y15	NC	NC	
5	IO_L44P_5	Y16	NC	NC	
5	IO_L43N_5	AC17	NC	NC	
5	IO_L43P_5	AB17	NC	NC	
5	IO_L39N_5	AA16	NC	NC	
5	IO_L39P_5	AA17	NC	NC	
5	IO_L38N_5	W16	NC	NC	
5	IO_L38P_5	Y17	NC	NC	
5	IO_L37N_5	AD18	NC	NC	
5	IO_L37P_5	AC18	NC	NC	
5	IO_L09N_5/VREF_5	AA18			
5	IO_L09P_5	Y18			
5	IO_L08N_5	AF19			
5	IO_L08P_5	AE19			
5	IO_L07N_5/VREF_5	AD19			
5	IO_L07P_5	AC19			
5	IO_L06N_5/VRP_5	AB18			
5	IO_L06P_5/VRN_5	AB19			
5	IO_L05_5/No_Pair	Y19			
5	IO_L03N_5/D4	AA19			
5	IO_L03P_5/D5	AA20			
5	IO_L02N_5/D6	AC20			
5	IO_L02P_5/D7	AB20			
5	IO_L01N_5/RDWR_B	AD21			
5	IO_L01P_5/CS_B	AC21			

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
2	IO_L59N_2		P8			
2	IO_L59P_2		P7			
2	IO_L60N_2		N4			
2	IO_L60P_2		N3			
2	IO_L85N_2		P3			
2	IO_L85P_2		P2			
2	IO_L86N_2		R8			
2	IO_L86P_2		R7			
2	IO_L87N_2		P5			
2	IO_L87P_2		P4			
2	IO_L88N_2/VREF_2		R2			
2	IO_L88P_2		T2			
2	IO_L89N_2		R6			
2	IO_L89P_2		R5			
2	IO_L90N_2		R4			
2	IO_L90P_2		R3			
3	IO_L90N_3		U1			
3	IO_L90P_3		V1			
3	IO_L89N_3		T5			
3	IO_L89P_3		T6			
3	IO_L88N_3		T3			
3	IO_L88P_3		T4			
3	IO_L87N_3/VREF_3		U2			
3	IO_L87P_3		U3			
3	IO_L86N_3		T7			
3	IO_L86P_3		T8			
3	IO_L85N_3		U4			
3	IO_L85P_3		U5			
3	IO_L60N_3		V2			
3	IO_L60P_3		W2			
3	IO_L59N_3		T9			
3	IO_L59P_3		U9			
3	IO_L58N_3		V3			
3	IO_L58P_3		V4			
3	IO_L57N_3/VREF_3		W1			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
2	IO_L05N_2	J8				
2	IO_L05P_2	J7				
2	IO_L06N_2	F5				
2	IO_L06P_2	F4				
2	IO_L15N_2	G4	NC			
2	IO_L15P_2	G3	NC			
2	IO_L16N_2/VREF_2	G6	NC			
2	IO_L16P_2	G5	NC			
2	IO_L17N_2	F2	NC			
2	IO_L17P_2	F1	NC			
2	IO_L18N_2	L10	NC			
2	IO_L18P_2	L9	NC			
2	IO_L19N_2	H6	NC			
2	IO_L19P_2	H5	NC			
2	IO_L20N_2	G2	NC			
2	IO_L20P_2	G1	NC			
2	IO_L21N_2	J6	NC			
2	IO_L21P_2	J5	NC			
2	IO_L22N_2/VREF_2	J4	NC			
2	IO_L22P_2	J3	NC			
2	IO_L23N_2	K8	NC			
2	IO_L23P_2	K7	NC			
2	IO_L24N_2	H4	NC			
2	IO_L24P_2	H3	NC			
2	IO_L31N_2	H2				
2	IO_L31P_2	H1				
2	IO_L32N_2	M10				
2	IO_L32P_2	M9				
2	IO_L33N_2	K5				
2	IO_L33P_2	K4				
2	IO_L34N_2/VREF_2	J2				
2	IO_L34P_2	K2				
2	IO_L35N_2	L8				
2	IO_L35P_2	L7				
2	IO_L36N_2	L6				
2	IO_L36P_2	L5				
2	IO_L37N_2	K1				
2	IO_L37P_2	L1				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
6	IO_L01P_6/VRN_6	AJ30				
6	IO_L01N_6/VRP_6	AJ31				
6	IO_L02P_6	AJ27				
6	IO_L02N_6	AJ28				
6	IO_L03P_6	AK31				
6	IO_L03N_6/VREF_6	AK32				
6	IO_L04P_6	AH29				
6	IO_L04N_6	AH30				
6	IO_L05P_6	AH27				
6	IO_L05N_6	AG28				
6	IO_L06P_6	AL33				
6	IO_L06N_6	AL34				
6	IO_L15P_6	AG29	NC			
6	IO_L15N_6/VREF_6	AG30	NC			
6	IO_L16P_6	AK33	NC			
6	IO_L16N_6	AK34	NC			
6	IO_L17P_6	AF27	NC			
6	IO_L17N_6	AF28	NC			
6	IO_L18P_6	AJ33	NC			
6	IO_L18N_6	AJ34	NC			
6	IO_L19P_6	AH31	NC			
6	IO_L19N_6	AH32	NC			
6	IO_L20P_6	AD25	NC			
6	IO_L20N_6	AD26	NC			
6	IO_L21P_6	AG31	NC			
6	IO_L21N_6/VREF_6	AG32	NC			
6	IO_L22P_6	AF29	NC			
6	IO_L22N_6	AF30	NC			
6	IO_L23P_6	AE27	NC			
6	IO_L23N_6	AE28	NC			
6	IO_L24P_6	AH33	NC			
6	IO_L24N_6	AH34	NC			
6	IO_L31P_6	AF31				
6	IO_L31N_6	AF32				
6	IO_L32P_6	AC25				
6	IO_L32N_6	AC26				
6	IO_L33P_6	AG33				
6	IO_L33N_6/VREF_6	AG34				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
6	IO_L34P_6	AE30				
6	IO_L34N_6	AE31				
6	IO_L35P_6	AD27				
6	IO_L35N_6	AD28				
6	IO_L36P_6	AF33				
6	IO_L36N_6	AE33				
6	IO_L37P_6	AD29				
6	IO_L37N_6	AD30				
6	IO_L38P_6	AB25				
6	IO_L38N_6	AB26				
6	IO_L39P_6	AD31				
6	IO_L39N_6/VREF_6	AD32				
6	IO_L40P_6	AC28				
6	IO_L40N_6	AC29				
6	IO_L41P_6	AB27				
6	IO_L41N_6	AB28				
6	IO_L42P_6	AE34				
6	IO_L42N_6	AD34				
6	IO_L43P_6	AC31				
6	IO_L43N_6	AC32				
6	IO_L44P_6	AA25				
6	IO_L44N_6	AA26				
6	IO_L45P_6	AD33				
6	IO_L45N_6/VREF_6	AC33				
6	IO_L46P_6	AB29				
6	IO_L46N_6	AB30				
6	IO_L47P_6	AA27				
6	IO_L47N_6	AA28				
6	IO_L48P_6	AB31				
6	IO_L48N_6	AB32				
6	IO_L49P_6	AA29				
6	IO_L49N_6	AA30				
6	IO_L50P_6	Y25				
6	IO_L50N_6	Y26				
6	IO_L51P_6	AC34				
6	IO_L51N_6/VREF_6	AB34				
6	IO_L52P_6	AA31				
6	IO_L52N_6	AA32				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
N/A	GND	P17				
N/A	GND	P18				
N/A	GND	P19				
N/A	GND	P20				
N/A	GND	P21				
N/A	GND	R8				
N/A	GND	R14				
N/A	GND	R15				
N/A	GND	R16				
N/A	GND	R17				
N/A	GND	R18				
N/A	GND	R19				
N/A	GND	R20				
N/A	GND	R21				
N/A	GND	R27				
N/A	GND	T1				
N/A	GND	T14				
N/A	GND	T15				
N/A	GND	T16				
N/A	GND	T17				
N/A	GND	T18				
N/A	GND	T19				
N/A	GND	T20				
N/A	GND	T21				
N/A	GND	T34				
N/A	GND	U14				
N/A	GND	U15				
N/A	GND	U16				
N/A	GND	U17				
N/A	GND	U18				
N/A	GND	U19				
N/A	GND	U20				
N/A	GND	U21				
N/A	GND	V14				
N/A	GND	V15				
N/A	GND	V16				
N/A	GND	V17				
N/A	GND	V18				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
5	IO_L69P_5	AJ18		
5	IO_L68N_5	AF18		
5	IO_L68P_5	AG18		
5	IO_L67N_5	AM19		
5	IO_L67P_5	AN19		
5	IO_L66N_5/VREF_5	AH19	NC	
5	IO_L66P_5	AJ19	NC	
5	IO_L57N_5/VREF_5	AN20		
5	IO_L57P_5	AP20		
5	IO_L56N_5	AD19		
5	IO_L56P_5	AE19		
5	IO_L55N_5	AL19		
5	IO_L55P_5	AM20		
5	IO_L54N_5	AJ20		
5	IO_L54P_5	AK20		
5	IO_L53_5/No_Pair	AG19		
5	IO_L50_5/No_Pair	AH20		
5	IO_L49N_5	AN21		
5	IO_L49P_5	AP21		
5	IO_L48N_5	AL21		
5	IO_L48P_5	AM21		
5	IO_L47N_5	AD20		
5	IO_L47P_5	AE20		
5	IO_L46N_5	AJ21		
5	IO_L46P_5	AK21		
5	IO_L45N_5/VREF_5	AG21		
5	IO_L45P_5	AH21		
5	IO_L44N_5	AD21		
5	IO_L44P_5	AE21		
5	IO_L43N_5	AM22		
5	IO_L43P_5	AN22		
5	IO_L39N_5	AH22		
5	IO_L39P_5	AJ22		
5	IO_L38N_5	AF20		
5	IO_L38P_5	AF21		
5	IO_L37N_5	AN23		
5	IO_L37P_5	AP23		
5	IO_L27N_5/VREF_5	AL22		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
6	IO_L06N_6	AM34		
6	IO_L07P_6	AN30		
6	IO_L07N_6	AM30		
6	IO_L08P_6	AM26		
6	IO_L08N_6	AL26		
6	IO_L09P_6	AM28		
6	IO_L09N_6/VREF_6	AM29		
6	IO_L10P_6	AL33		
6	IO_L10N_6	AL34		
6	IO_L11P_6	AL27		
6	IO_L11N_6	AK27		
6	IO_L12P_6	AL29		
6	IO_L12N_6	AL30		
6	IO_L13P_6	AL32		
6	IO_L13N_6	AK32		
6	IO_L14P_6	AJ27		
6	IO_L14N_6	AJ28		
6	IO_L15P_6	AL31		
6	IO_L15N_6/VREF_6	AK31		
6	IO_L16P_6	AL28		
6	IO_L16N_6	AK28		
6	IO_L17P_6	AJ26		
6	IO_L17N_6	AH26		
6	IO_L18P_6	AJ33		
6	IO_L18N_6	AJ34		
6	IO_L19P_6	AJ31		
6	IO_L19N_6	AJ32		
6	IO_L20P_6	AG27		
6	IO_L20N_6	AG28		
6	IO_L21P_6	AK29		
6	IO_L21N_6/VREF_6	AJ29		
6	IO_L22P_6	AH33		
6	IO_L22N_6	AH34		
6	IO_L23P_6	AF27		
6	IO_L23N_6	AE27		
6	IO_L24P_6	AJ30		
6	IO_L24N_6	AH30		
6	IO_L25P_6	AH28		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP19		
N/A	GND	AK19		
N/A	GND	AF19		
N/A	GND	AA19		
N/A	GND	Y19		
N/A	GND	W19		
N/A	GND	V19		
N/A	GND	U19		
N/A	GND	T19		
N/A	GND	R19		
N/A	GND	P19		
N/A	GND	J19		
N/A	GND	E19		
N/A	GND	A19		
N/A	GND	AP18		
N/A	GND	AA18		
N/A	GND	Y18		
N/A	GND	W18		
N/A	GND	V18		
N/A	GND	U18		
N/A	GND	T18		
N/A	GND	R18		
N/A	GND	P18		
N/A	GND	A18		
N/A	GND	AA17		
N/A	GND	Y17		
N/A	GND	W17		
N/A	GND	V17		
N/A	GND	U17		
N/A	GND	T17		
N/A	GND	R17		
N/A	GND	P17		
N/A	GND	AP16		
N/A	GND	AK16		
N/A	GND	AF16		
N/A	GND	AA16		
N/A	GND	Y16		
N/A	GND	W16		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	GND	W18		
N/A	GND	V18		
N/A	GND	U18		
N/A	GND	T18		
N/A	GND	AD17		
N/A	GND	AC17		
N/A	GND	AB17		
N/A	GND	AA17		
N/A	GND	Y17		
N/A	GND	W17		
N/A	GND	V17		
N/A	GND	U17		
N/A	GND	P20		
N/A	GND	L20		
N/A	GND	G20		
N/A	GND	C20		
N/A	GND	AD19		
N/A	GND	AC19		
N/A	GND	AB19		
N/A	GND	AA19		
N/A	GND	Y19		
N/A	GND	W19		
N/A	GND	V19		
N/A	GND	U19		
N/A	GND	T19		
N/A	GND	AD18		
N/A	GND	AC18		
N/A	GND	U21		
N/A	GND	T21		
N/A	GND	AU20		
N/A	GND	AN20		
N/A	GND	AJ20		
N/A	GND	AF20		
N/A	GND	AD20		
N/A	GND	AC20		
N/A	GND	AB20		
N/A	GND	AA20		
N/A	GND	Y20		

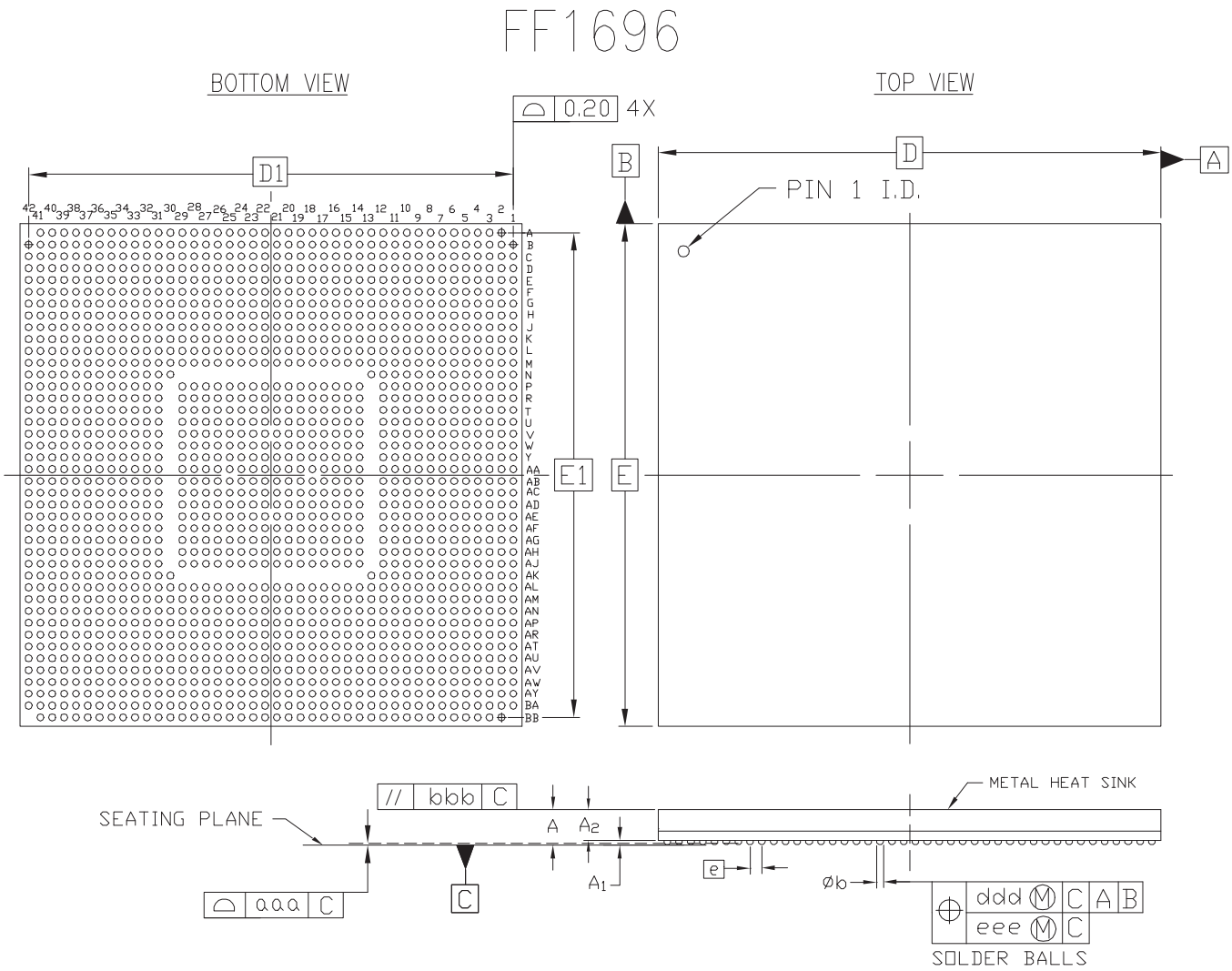
Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	TXPPAD7		A20		
N/A	GNDA7		C21		
N/A	RXPPAD7		A19		
N/A	RXNPAD7		A18		
N/A	VTRXPAD7		B19		
N/A	AVCCAUXRX7		B18		
N/A	AVCCAUXTX8		B16		
N/A	VTTXPAD8		B17		
N/A	TXNPAD8		A17		
N/A	TXPPAD8		A16		
N/A	GNDA8		C16		
N/A	RXPPAD8		A15		
N/A	RXNPAD8		A14		
N/A	VTRXPAD8		B15		
N/A	AVCCAUXRX8		B14		
N/A	AVCCAUXTX9		B12		
N/A	VTTXPAD9		B13		
N/A	TXNPAD9		A13		
N/A	TXPPAD9		A12		
N/A	GNDA9		C12		
N/A	RXPPAD9		A11		
N/A	RXNPAD9		A10		
N/A	VTRXPAD9		B11		
N/A	AVCCAUXRX9		B10		
N/A	AVCCAUXTX10		B8		
N/A	VTTXPAD10		B9		
N/A	TXNPAD10		A9		
N/A	TXPPAD10		A8		
N/A	GNDA10		C8		
N/A	RXPPAD10		A7		
N/A	RXNPAD10		A6		
N/A	VTRXPAD10		B7		
N/A	AVCCAUXRX10		B6		
N/A	AVCCAUXTX11		B4		
N/A	VTTXPAD11		B5		
N/A	TXNPAD11		A5		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
3	IO_L06N_3	BA8	
3	IO_L06P_3	BB8	
3	IO_L05N_3	AW8	
3	IO_L05P_3	AW9	
3	IO_L04N_3	BA7	
3	IO_L04P_3	BB7	
3	IO_L03N_3/VREF_3	BA6	
3	IO_L03P_3	BB6	
3	IO_L02N_3	AY9	
3	IO_L02P_3	BA9	
3	IO_L01N_3/VRP_3	BA4	
3	IO_L01P_3/VRN_3	BB4	
4	IO_L01N_4/BUSY/DOUT(1)	AL11	
4	IO_L01P_4/INIT_B	AL12	
4	IO_L02N_4/D0/DIN(1)	AV10	
4	IO_L02P_4/D1	AU10	
4	IO_L03N_4/D2	AN11	
4	IO_L03P_4/D3	AM11	
4	IO_L05_4/No_Pair	AT10	
4	IO_L06N_4/VRP_4	AY11	
4	IO_L06P_4/VRN_4	AY10	
4	IO_L07N_4	BB10	
4	IO_L07P_4/VREF_4	BA10	
4	IO_L08N_4	AU11	
4	IO_L08P_4	AT11	
4	IO_L09N_4	AR11	
4	IO_L09P_4/VREF_4	AP11	
4	IO_L19N_4	AW11	
4	IO_L19P_4	AV11	
4	IO_L20N_4	BB11	
4	IO_L20P_4	BA11	
4	IO_L21N_4	AN12	
4	IO_L21P_4	AM12	
4	IO_L25N_4	AR13	
4	IO_L25P_4	AT12	
4	IO_L26N_4	AV12	

FF1696 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)



SYMBOL	MILLIMETERS			NOTE
	MIN.	NOM.	MAX.	
A		3.20	3.45	
A_1	0.40	0.50	0.60	
A_2			2.85	
D/E	42.50 BASIC			
D_1/E_1	41.00 REF			
e	1.00 BASIC			
øb	0.50	0.60	0.70	
aaa			0.20	
bbb			0.25	
ddd			0.25	
eee			0.10	
M		42		2

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ASME Y14.5M–1994
2. SYMBOL "M" IS THE PIN MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–AAV–1 (DEPOPULATED)

Figure 10: **FF1696 Flip-Chip Fine-Pitch BGA Package Specifications**